

Inner triplet BPM manufacturing

Dmitry Gudkov SY-BI-ML

11th HL-LHC Collaboration Meeting - WP13 Beam Instrumentation — 21.10.2021

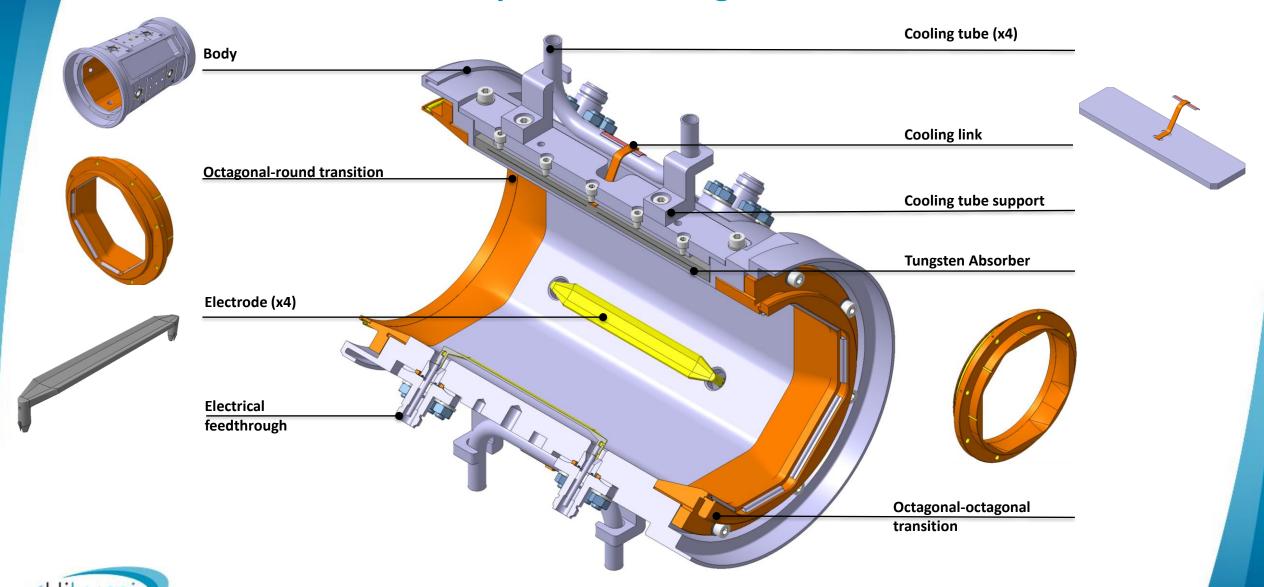
Dmitry Gudkov 1

Content

- BPM Components Manufacturing
 - BPM Body
 - Transitions
 - Cooling links
 - Electrodes
- Scope of work at CERN and BINP
- Quality Assurance
- Tooling
- Status of CERN Pre-series
- Conclusions



Inner Triplet BPM Design Overview



BPM Body Manufacturing

Machining

Cleaning

Leak tightness test

Metrological control

Gold/Copper coating

Welding of cooling tubes

Welding quality control

Metrological control

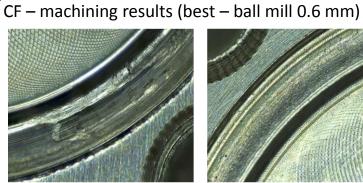
Leak tightness test

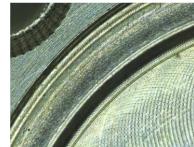
Packaging

- Material: CERN material spec. 1001 for 1.4429 round, forged blanks
- Strict tolerances
- Machined ConFlat interfaces
- Octagonal shape (electroerosion wire cutting)
- Copper electroplating 0.1 mm (with gold flash for adhesion)

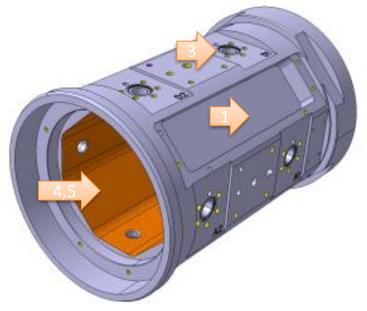


BPM Proto, ACC

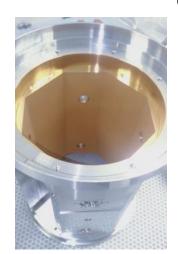




EE-wire cut, Ra3.2













BPM Body Manufacturing – mock-up in 180







BPM Transitions Manufacturing

Machining of bases and inserts, cutting and forming of RF contacts

Cleaning of parts

Metrological control

Electron-beam welding

Metrological control

Welding quality control

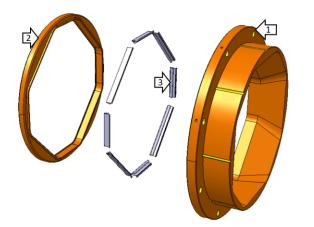
Packaging

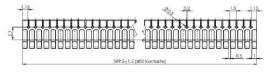
- CERN material spec. 2000 for Oxygen-Free Electronic copper sheets – transition parts
- CuBe 17410 electric contacts
- Electrical contacts are supplied in form of 600 mm strips



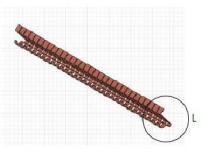
LHCBPMQST_B0003

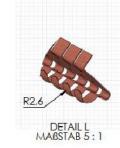






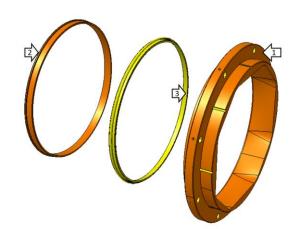


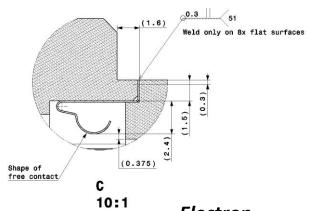




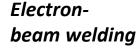
LHCBPMQST B0004







8x





BPM Cooling Link Manufacturing

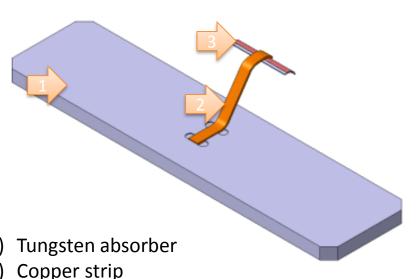
Weld interface plate and cooling strip

Braze interface plate-cooling strip subassmbly to the tungsten absorber

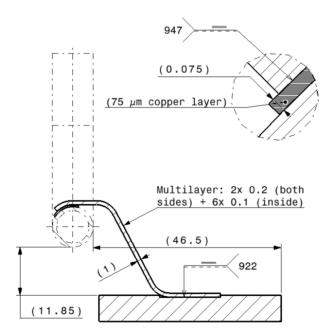
Quality control

Packaging

- 1. Tungsten absorbers will be supplied by the TE-VSC (40 received)
- 2. Copper strip and interface plate are welded (ultrasound welding)
- 3. Then the strip-interface plate subassembly is brazed to tungsten block



Interface plate (is laser-welded to the cooling tube)



The subassemblies are then welded to the cooling tubes of the BPM body

CERN Workshop has developed the manufacturing process which will be used to produce 100 pcs. subassemblies



BPM Electrodes Manufacturing

Machining of electrodes

Cleaning of parts

Metrological control

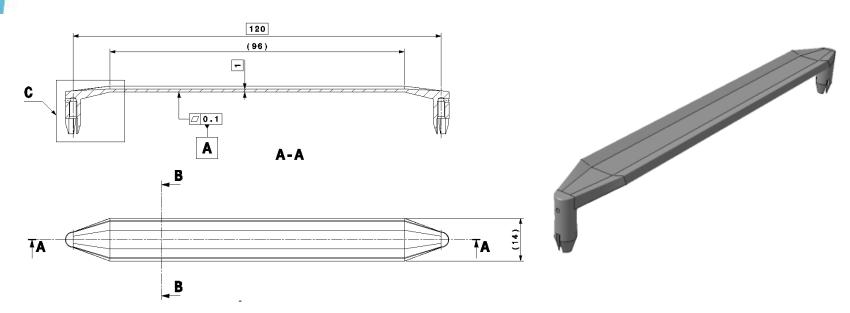
Gold flash/Copper control

Coating control

ACc

Packaging

- Iterative design, several prototypes have been manufactured
- Strict tolerances
- Material: CERN material spec. 1000 for 1.4429 round, forged round bars







Scope of work at CERN and BINP

Scope of work is covered by two engineering specifications:

- Scope of work by BINP
- **Scope of work by CERN** (including MME workshop, commercial components procurement, operations done at CERN, assembly and testing)



Scope of work (BINP)
https://edms.cern.ch/d
ocument/2387693/1.6



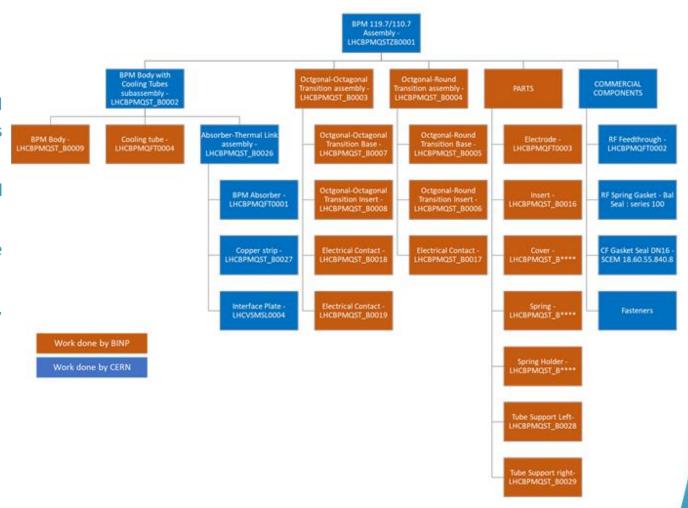
Scope of work (CERN)
https://edms.cern.ch/d
ocument/2338015/1.2



Scope of work at CERN and BINP

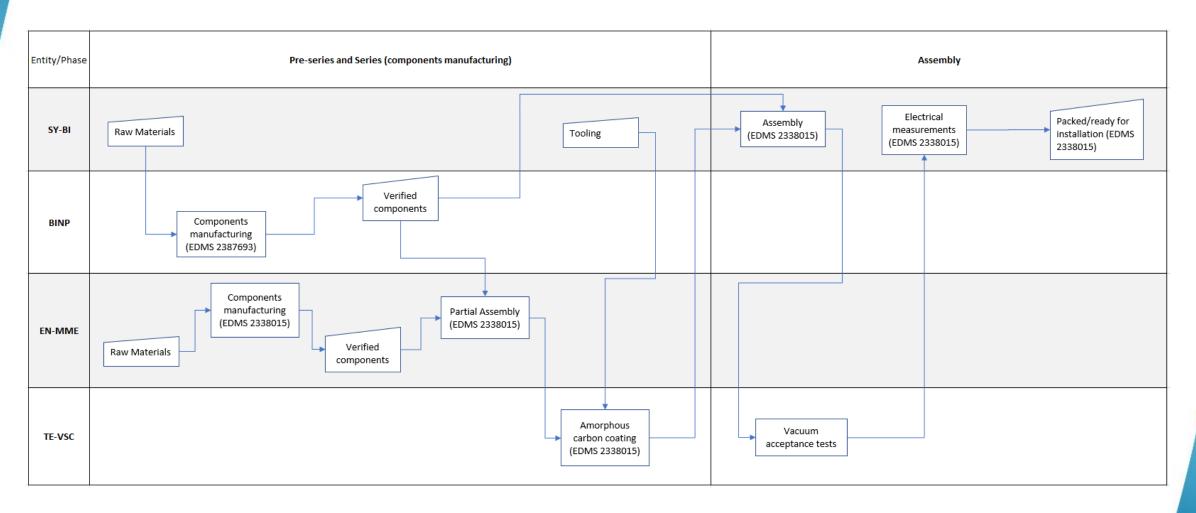
BPMQSTZB - LHCBPMQSTZB0001 x22

- Assembly of the BPMs will be performed at CERN
- Assembly of tungsten absorbers with cooling links and interface plates will be done at CERN (MME has a process used for Beam Screen, they can do 100 pcs. for us)
- All the raw materials will be purchased by CERN and shipped to BINP
- All fasteners will be purchased by CERN (no need to have them in BINP as assembly will be done here)
- Commercial components (electrical feedthroughs, CF gaskets, RF springs, electrical contacts) will be purchased by CERN
- All machining work will be done by BINP
- Electron-beam welding of transitions will be done by BINP
- Copper coating of bodies will be done by BINP
- Preassembly of bodies and transitions BINP
- Amorphous carbon coating → at CERN





Scope of work at CERN and BINP





- CERN drawings are released (control 2)
- Three drawing folders with final drawings are in "HL Engineering Check" Status

https://edms.cern.ch/document/2005150/2.5 - LHCBPMQSTZB0001 - BPM INNER TRIPLET Type B https://edms.cern.ch/document/2370344/1.5 - LHCBPMQSTZA0001 - BPM INNER TRIPLET Type A https://edms.cern.ch/document/2370347/1.5 - LHCBPMQBCZA0001 + LHCBPMQBCZB0001 = BPM INNER TRIPLET D2

- The quality management is performed in collaboration with HL Quality Team (Hector)
- The BPM items have been created and stored under the EDMS node: https://edms.cern.ch/project/CERN-0000175704
- MIPs are created for all types of components with control points identified
- There are MIPs for BINP which are linked to higher-level MIPs as per scope distribution between CERN and BINP
 - BINP also verified the drawings and provided feedback. No major comments submitted
 - BINP will produce their drawings based on CERN drawings, and CERN will approve them before starting the production
 - CERN procedures exist (or in preparation) for: Welding, Cleaning, Copper and gold coating, Leak tests, Amorphous carbon coating
- A P HCBPMQSTZB001 (v.0) ASSEMBLY OCTAGONAL 119.7/110.7 STRIPLINI ■ PHCBPMQST_B002 (v.0) SUBASSEMBLY BPM BODY WITH COOLING FHCBPMQST_B009 (v.0) OCTOGONAL 119.7/123.7 BPM BODY LHCBPMQST_B0009 (v.0) OCTAGONAL BODY 2365075 (v.1) MIP_HCBPMQST_B009_Body LHCBPMQST_B0002 (v.0) BODY WITH COOLING PIPES AND ABS 2488263 (v.1) MIP_HCBPMQST_B002 ▲ F HCBPMQST_B004 (v.0) ASSEMBLY OCTAGONAL-ROUND TRANSITION 2480159 (v.1) MIP_HCBPMQST_B004_ASSEMBLY_OCTAGONAL-▲ F HCBPMQST_B003 (v.0) ASSEMBLY OCTAGONAL TRANSITION 119.7/ 2480151 (v.1) MIP_HCBPMQST_B003_Assembly_Octagonal-Octag ▲ PHCBPMQFT002 (v.0) HL-LHC IT STRIPLINE BPM RF FEEDTHROUGH LHCBPMQFT0002 (v.AA) HL-LHC IT STRIPLINE BPM RF FEEDTH ▲ P HCBPMQFT003 (v.0) HL-LHC IT STRIPLINE BPM ELECTRODE 2488296 (v.1) MIP_HCBPMQFT003 ■ LHCBPMQSTZB0001 (v.0) OCTAGONAL STRIPLINE BPM ASSEMBLY 2338015 (v.1.2) Engineering Specification for the supply of the Mechani 2385616 (v.1) IR1&IR5 heat loads in the IT BPMs due to collision debris LHC-BPMQ-ES-0004 (v.0.5) Functional Specification - CRYOGENIC DI LHC-BPMQ-ER-0001 (v.1.2) RAW MATERIAL BLANKS DIMENSIONS |≡| 2387693 (v.1.6) Engineering Specification for the supply of the Mechanic Delian 2005150 (v.2.5) LHCBPMQSTZB0001 - BPM INNER TRIPLET Type B CBPMQSTZA001 (v.0) ASSEMBLY OCTAGONAL 99.7/99.7 STRIPLINE H HCBPMQBCZA001 (v.0) D2 BPM 1 ASSEMBLY



		HL-LHC: Quality														
	Manufacturing and Inspection Plan															
_	Prepared by: D. Gudkov Date: 06/02/2021 Verified by: N. Surname			Project: HL-LHC				Supplier: BINP			Item Eq. Code: LHCBPM			Asset Code (LHC Part Identifier): HCBPMQST_B009		
_	Date: DD/MM/20YY			Work Package: WP13			Client: CERN (SY-BI-ML)			Item description: BPM BODY			EDMS Report No:			
	Approved by: N. Surname Date: DD/MM/20YY			WORK PACKAGE: WF13												
	No	ACTIVITY / OPÉRATION	APPL STANDAR DS / NORMES APPL	APPLICABLE DOCUMENTS / DOCUMENTS APPLICABLES	REV. DOC.	INSPECTION				/ CONTRÔLE						
						SUPPLIER / C		ONTRÔLE	CLIENT / VÉRIFICATION		3 PARTY / SURVEILLANCE		INSPECTION REPORT /		REV.	NOTES / COMMENTAIRES
						Code	Sign	ature/Date	Code	Signature/Date	Code	Signature/Date	RAPPORT D'INSPECTION		DOC.	
	1	Receive and verify raw materials		EDMS 2387693 (for blanks dimensions)					w					Vlaterials eptance t in MTF		Raw materials are procured by CERN and shipped to BINP
	2	Machining		LHCBPMQST_B0009												
	2.1.	BPM body degreasing														
	2.2	Dimensional control		LHCBPMQST_B0009					R				Dimensi control r			
	3	Electroplating		LHCBPMQST_B0009												
	3.1	Gold strike electroplating		EDMS 2387693												
	3.2	Visual control		EDMS 2387693												
	3.3	Copper coating (0.1 mm thick)		EDMS 2387693												
	3.4	Dimensional control		LHCBPMQST_B0009					R				Dimensi control r			
	5	Packaging/storage		EDMS 2387693					N				Photog	raph		



						Н	L-LHC:	Qua	ality						
	Manufacturing and Inspection Plan														
Date: 0	ed by: D. Gudkov 06/02/2021 d by: N. Surname	Project: HL-LHC				Supplier: CERN (EN-MME)			Item Eq. Code: LHCBPM			Asset Code (LHC Part Identifier): HCBPMQST_B002			
Date: DD/MM/20YY Approved by: N. Surname			Work Package: WP13				Client: CERN (SY-BI-ML)			Item description: BODY WITH COOLING PIPES AND ABSORBERS			EDMS Report No:		
Date: [DD/MM/20YY								The second of th						
		APPL STANDAR DS / NORMES APPL	APPLICABLE DOCUMENTS / DOCUMENTS APPLICABLES	REV. DOC.	INSPECTION / CONTRÔLE										
No	ACTIVITY / OPÉRATION				SUPPLIER / C		ONTRÔLE CLIENT		IT / VÉRIFICATION	3 ND PARTY / SURVEILLANCE		INSPECTION REPORT /		REV.	NOTES / COMMENTAIRES
					Code	Signa	ature/Date	Code	Signature/Date	Code	Signature/Date	RAPPO D'INSPEC			
1	RECEIVE AND VERIFY COMPONENTS							R					nspection eport		By CERN (SY-BI-ML)
1.1	BPM Body		LHCBPMQST_B0009 MTF records												Manufactured by t BINP (MIP EDI 2365075)
1.2	Cooling tube		LHCBPMQFT0004												Manufactured by t
1.3	HL-LHC IT STRIPLINE BPM ABSORBER		LHCBPMQFT0001												Procured by TE-VSC
2	WELDING OF 4 COOLING TUBES LHCBPMQFT0004 ON THE BPM BODY		LHCBPMQST_B0002												
2.1.	Welding														
2.2	Dimensional control		LHCBPMQST_B0002					R				Dimensi control r			
3	ABSORBER WITH THERMAL BRIDGE		LHCBPMQST_B0026					_							
3.1	Thermal links		LHEBPMQST_B0027												



Qualification tests planned in BINP:

- ConFlat Geometry Machining + Quality Control + Leak Test
- Gold and Copper coating quality with use of witness piece (tube)

CERN raw materials tracking in BINP:

- BINP shall define a stock control program for all materials.
- All materials shall be kept locked in a particular room exclusively devoted to this aim.
- Access shall be limited to a named QA officer.
- All materials entering or leaving this stock shall be permanently marked and logged by the QA officer and recorded in the corresponding certificates such that full traceability from CERN to each finished component is ensured.
- Tracking with CERN asset management.

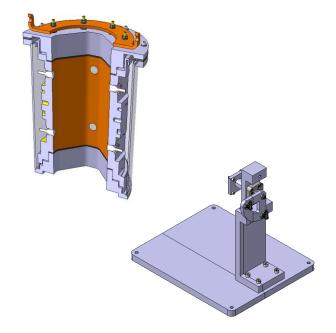


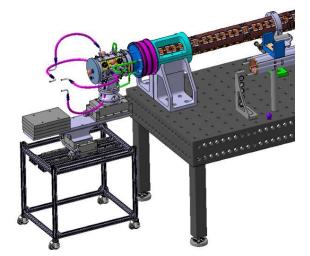




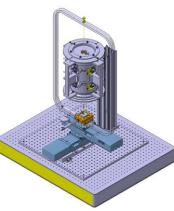
Tooling

#	Tooling	Complexity (1-10)	Design	Manufacturing
1	Gold Electroplating Tooling for BPM type A	6	COMPLETE	IN PROGRESS
2	Gold Electroplating Tooling for BPM type B	6	COMPLETE	IN PROGRESS
3	Gold Electroplating Tooling for BPM type D2	6	COMPLETE	IN PROGRESS
4	Copper Electroplating Tooling for BPM type A	6	COMPLETE	IN PROGRESS
5	Copper Electroplating Tooling for BPM type B	6	COMPLETE	IN PROGRESS
6	Copper Electroplating Tooling for BPM type D2	6	COMPLETE	IN PROGRESS
7	Amorphous carbon coating tooling for BPM type A/B	8	NOT STARTED	NOT STARTED
8	Amorphous carbon coating tooling for BPM type D2	8	NOT STARTED	NOT STARTED
9	Assembly tooling (tilting mechanism)	2	COMPLETE	COMPLETE
10	Leak test flanges (quality control)	2	IN PROGRESS	NOT STARTED
11	Alignment and leak test flange for BPM type A/B (installation)	4	IN PROGRESS	NOT STARTED
12	Alignment and leak test flange for BPM type D2 (installation)	4	IN PROGRESS	NOT STARTED
13	Positioning tooling for BPM type A/B (installation)	4	NOT STARTED	NOT STARTED
14	Positioning tooling for BPM type D2 (installation)	4	NOT STARTED	NOT STARTED
15	Tooling for BPM alignment and installation on the beam screen (type A/B)	10	IN PROGRESS	NOT STARTED
16	Tooling for BPM alignment and installation on the beam screen (type D2)	10	IN PROGRESS	NOT STARTED
17	Electrical measurements bench	10	IN PROGRESS	NOT STARTED
18	Electrodes verification bench	6	NOT STARTED	NOT STARTED
19	Buttons verification bench	6	NOT STARTED	NOT STARTED
20	Feedtrhoughs verification bench	6	NOT STARTED	NOT STARTED











Status of CERN Pre-series

- Machining is in progress.
- Ready for next operations as per production plan Q1 2022.









Conclusions

- SY-BI is working closely with HL-LHC Project office to refine processes and documentation for CERN-BINP collaboration in alignment with HL-LHC Quality Plan
- SY-BI together with CERN EN-MME Workshop elaborated an optimized manufacturing processes to achieve the best quality of BPM components
- SY-BI have re-started the technical discussions with the BINP on planned manufacturing of the BPM components catch-up every 3 weeks (E. Pyata, A. Krasnov, T. Bedareva)
- The CERN Pre-series is well advanced. The work will be continued in 2022 by EN-MME, SY-BI and TE-VSC
- Many tools to be designed and manufactured. The design for most of them is in progress
- Overall, the manufacturing process of all the components and assemblies is well
 understood due to manufacturing studies and prototypes



Thank you for your attention!



Quality Assurance. Future actions

- BINP should have access to MTF (1 person should be managing BINP quality documentation) → someone from BINP workshop?
- This person should be trained on using MTF: HL-LHC P.O. provides such a training
- MIP, Spec. and drawings will be sent to BINP for the manufacturing processes validation. In case BINP wants to change MIP or drawings, these changes should be validated by CERN before manufacturing can start
- BINP can create their own drawings based on CERN drawings, however the quality control will be performed based on CERN drawings

